

310nm UVC LED

- SMD

 Iow, medium & high power
- Chip on Board (COB)
- Light Bars (12x1)
- Application Sets Plug-and-Play

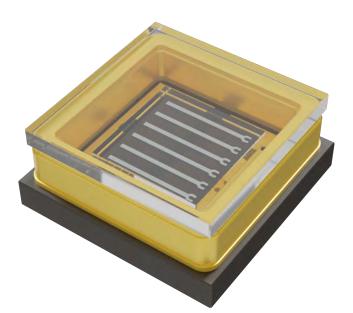
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WS3535C48LF-310 Low Power UVB LED SMD

WS3535C48LF-310 is a UV LED Surface Mount Device (SMD) offering UV radiation at a peak wavelength of 308±5nm. The WS3535C48LF series is packaged in a single-chip structure equipped with a flat window lens for low power UV output. With its conventional pad structure and compact size, the WS3535C48LF series is suitable for applications requiring low UV output and energy consumption.



FEATURES & BENEFITS

- Optical output up to 42mW
- Dimensions: 3.5x3.5mm
- Equipped with 130° flat lens
- Ideal for low power applications

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Revised August 6, 2021

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Low Power UVB LED SMD

Electro-Optical Characteristics at T=25°C and $\rm I_{\rm F}$ =350mA

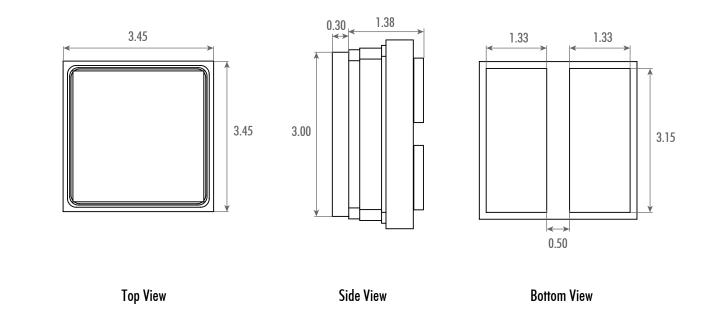
Parameter	Symbol	Unit	Min	Typical	Max
Peak Wavelength	$\lambda_{\rm P}$	nm	303	308	313
Forward Voltage	V _F	V	-	5.7	-
Radiant Flux	P_{o}	mW	32	37	42
Full Width of Half Magnitude	Δλ	nm	-	13.6	-
Radiant Angle	2Φ _{1/2}	Degree	-	130	-
Thermal Resistance, Junction to Solder Joint	R _{th} (J-S)	°C/W	-	9	-

Absolute Maximum Ratings

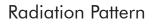
Parameter	Symbol	Unit	Value
Forward Current	I _F	mA	700
Reverse Voltage	V _R	V	5
Power	Po	W	4.5
Junction Temperature	T,	°C	90
Operating Temperature	T _{opr}	°C	-30 ~ 85
Storage Temperature	T _{stg}	°C	-40 ~ 100

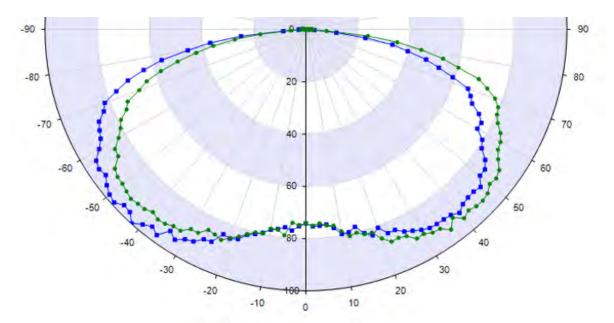
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Low Power UVB LED SMD



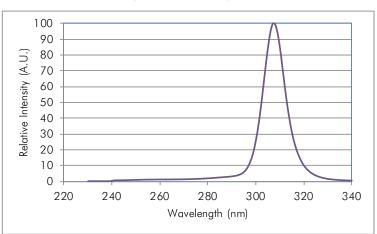
Mechanical Dimensions





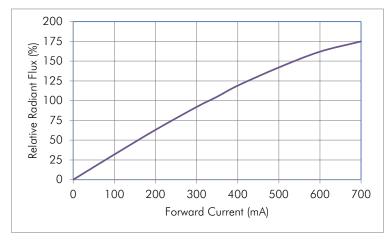
Low Power UVB LED SMD

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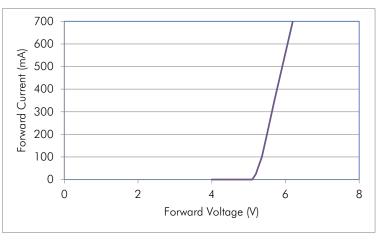


Spectral Output

Forward Current vs. Relative Radiant Flux

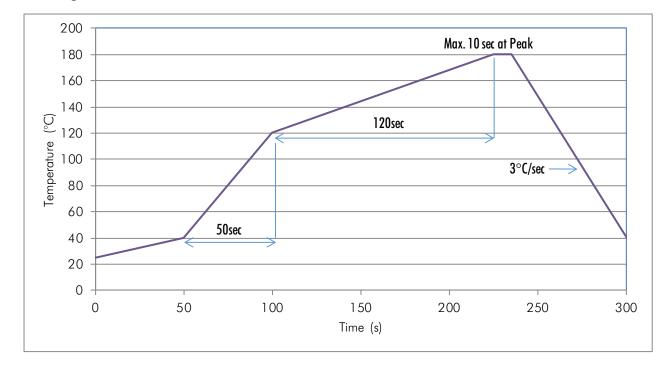


Forward Voltage vs. Forward Current



Low Power UVB LED SMD

Soldering Guidelines



Handling & Usage Precautions

- Exhibit extreme care when handling LEDs. Do not touch the LED with bare hands as doing so may contaminate and affect the optical characteristics of the LED. When using tweezers, do not apply excessive force, especially to the glass lens. Do not drop the LED as doing so may cause product damage.
- Ensure that electrostatic discharge specifications are followed. Static electricity and surge voltages may cause product damage. Proper electrostatic discharge protection equipment, working machinery, and protected mounting equipment are recommended.
- Do not expose the LEDs to volatile organic compounds as well as hazardous, acidic, and corrosive substances during storage and operation to avoid product damage.
- Do not apply excess mechanical force and vibration while handling the product.
- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation.
- Ensure that the PCB is suitable for the product and be wary of LED placement and possible PCB warpage.

Storage Precautions

- Perform soldering as soon as the moisture-proof packaging is opened.
- After the storage duration has exceeded the recommended time, products may need to be baked before soldering.
- Store all products in a controlled environment under 30° C free of dust. Do not expose the product to sudden changes in temperature, high humidity levels, and condensation.
- Please consult the Violumas engineering team for further information on storage precautions.

Eye Safety Precautions

- Avoid exposure to UV light during LED operation. Do not look directly into the UV light during LED operation. Do
 not look directly into the UV light during optical measurements even through optical instruments. Protect the body,
 skin, and eyes with UV protective equipment.
- Attach warning labels on all products and systems that use UV LEDs.

Cleaning Precautions

- Do not use brushes or organic solvents for cleaning the LEDs.
- Perform electrical and optical measurements before and after cleaning to ensure optimal performance.

Static Electricity Precautions

- Ensure that equipment and machinery are properly grounded.
- Anti-electrostatic attire (wristbands, gloves, footwear, etc.) is recommended.
- Damage inspection is recommended while performing characteristics inspection of LEDs.

Disclaimers

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VS5252C48L6-310-V1 | Mid Power 310nm SMD

The VS5252C48L6-310-V1 is a mid power surface-mount-device (SMD) UV LED with a peak wavelength of 308±5nm. The SMD is structured with a patented 3-PAD LED Flip Chip mounted onto a copper-based Pillar substrate to boost output efficiency and reduce the thermal resistance. The VS5252C48L6-310-V1 is packaged in a single-chip structure with a 60° fused silica lens and is ideal for mid power UV applications.



*VS5252C48L6-310-V1 is also available with 30°, 120°, and 135° lenses. Please contact Violumas for specifications regarding alternative LED beam angles.

Features & Benefits

- Dimensions: 5.2mm x 5.2mm x 3.3mm
- Typical Peak Wavelength: 308nm
- Equipped with a 60° fused silica lens*
- Integrated thermal technology in LED chip and substrate for lowest thermal resistance & reduced thermal decay



Electro-Optical Characteristics at $\rm I_{\rm F}{=}700mA$ and $\rm T_{\rm A}{=}25^{\circ}C$

Parameter	Symbol	Unit	Min	Typical	Max
Peak Wavelength	$\lambda_{\rm P}$	nm	303	308	313
Forward Voltage	V _F	V	5.5	6.0	7.0
Radiant Flux	Po	mW	100	120	140
Full Width of Half Magnitude	Δλ	nm	-	15	-
Radiant Angle	2Φ _{1/2}	Degree	-	60	-
Thermal Resistance, Junction to Solder Joint	R _{th} (J-S)	°C/W	-	0.9	-

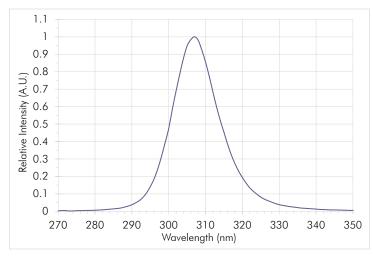
Peak Wavelength Tolerance: ±3nm; Forward Voltage Tolerance: 0.1V; Radiant Flux Tolerance: ±10%

Absolute Maximum Ratings

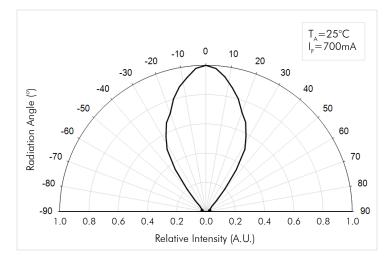
Parameter	Symbol	Unit	Value
Forward Current	۱ _F	mA	1000
Reverse Voltage	V _R	V	5
Power	P _D	W	6.5
Junction Temperature	T,	°C	90
Operating Temperature	T _{OPR}	°C	-30 ~ 85
Storage Temperature	T _{stg}	°C	-40 ~ 100

Note: Operating the LED at or above the listed absolute maximum ratings may affect device reliability and result in permanent LED failure.

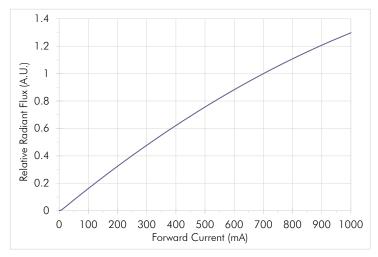
Spectral Output



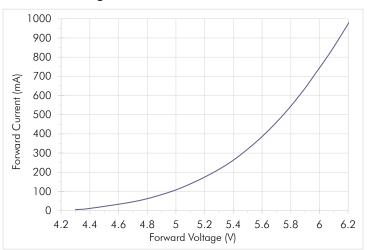
Radiation Pattern

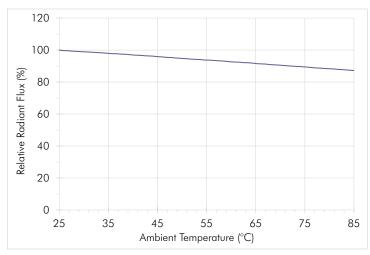


Forward Current vs. Relative Radiant Flux



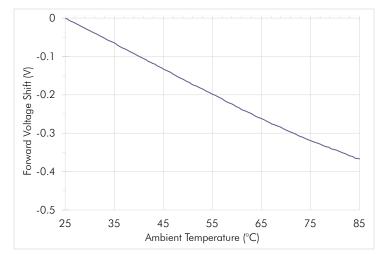
Forward Voltage vs. Forward Current



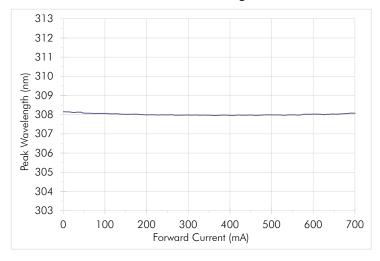


Ambient Temperature vs. Relative Radiant Flux

Ambient Temperature vs. Forward Voltage Shift



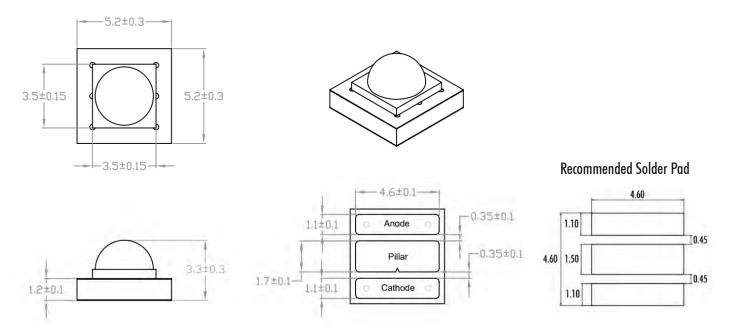
Forward Current vs. Peak Wavelength



VS5252C48L6-310-V1 Mid Power 310nm SMD

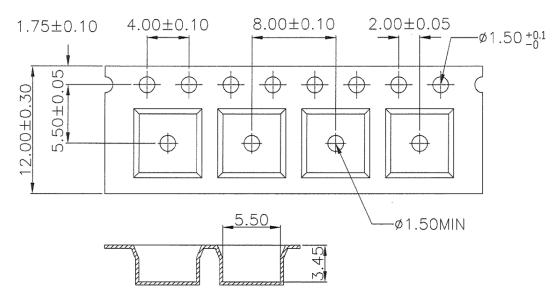
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Mechanical Dimensions



Note: The maximum offset (tolerance) for lens alignment over the LED is 0.2mm.

Reel Packaging Specifications

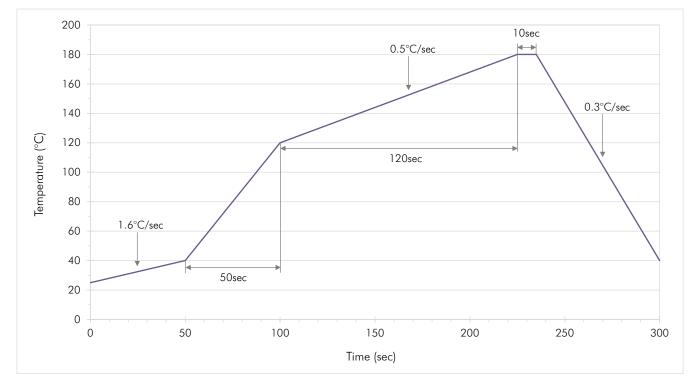


Each reel is loaded with 350 units and includes a leader section (200mm) and a trailer section (200mm) with empty pockets. The diameter of the reel is 177.8mm. Devices are placed with the anode to the left.

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Mid Power 310nm SMD

Soldering Guidelines



Reflow Profile Feature	Standard Parameters
Preheat Temperature Minimum	40°C
Preheat Temperature Maximum	120°C
Preheat Time	50 sec
Preheat Ramp-Up Rate	1.6°C/sec
Peak Temperature	±5°C
Time from Preheat Maximum Temperature to Peak Temperature	120 sec
Ramp-Up Rate from Maximum Temperature to Peak Temperature	0.5°C/sec
Time Within 5°C of Peak Temperature	5 sec
Maximum Time Maintained at Peak Temperature within Tolerance	10 sec
Ramp-Down Rate	3°C/sec

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Reliability Tests

Test	Conditions	Test Duration	Failed/Tested
Resistance to Soldering Heat	T _{sLD} =180°C, 10sec Precondition: 30°C, 70%RH, 168hrs	2 reflows	0/5
Thermal Shock	-45°C to 125°C, 15min	500 cycles	0/5
High Temperature Storage	T _A =100°C	1000 hrs	0/5
Low Temperature Storage	$T_A = -40^{\circ}C$	1000 hrs	0/5
Room Temperature Operating Life	T _A =25°C, I _F =700mA	1000 hrs	0/5
Wet High Temperature Operating Life	T _A =60°C, RH=90%, I _F =700mA	1000 hrs	0/5
Vibration	200m/s ² , 10~2000~100Hz 4cycles, 4min, on X/Y/Z axis	48 min	0/5

Failure Criteria: Forward Voltage (I_F =700mA) > Initial Value x 1.1; Radiant Flux (I_F =700mA) < Initial Value x 0.7

Handling & Usage Precautions

- Exhibit extreme care when handling LEDs. Do not touch the LED with bare hands as doing so may contaminate and affect the optical characteristics of the LED. When using tweezers, do not apply excessive force, especially to the glass lens. Do not drop the LED as doing so may cause product damage.
- Ensure that electrostatic discharge specifications are followed. Static electricity and surge voltages may cause product damage. Proper electrostatic discharge protection equipment, working machinery, and protected mounting equipment are recommended.
- Do not expose the LEDs to volatile organic compounds as well as hazardous, acidic, and corrosive substances during storage and operation to avoid product damage.
- Do not apply excess mechanical force and vibration while handling the product.
- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation.
- Ensure that the PCB is suitable for the product and be wary of LED placement and possible PCB warpage.
- To avoid fault issues, do not couple any electrical wires to the metal substrate of the MCPCB or COB. If any
 electrical wires from the power source have contact with the MCPCB's metal base under power ON conditions,
 permanent damage may occur due to inner arcing within the LED structure.
- Avoid grounding of the LED copper substrate. Transient charges can propagate from the ground to the heatsink and finally to the copper substrate of the LED unit and damage the dielectric layer from ground charges. An insulator must be placed between the heatsink and the benchtop to avoid transient charge propagation from the ground.

Storage Precautions

- Perform soldering as soon as the moisture-proof packaging is opened.
- After the storage duration has exceeded the recommended time, products may need to be baked before soldering.
- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation. It is recommended to store all products in a controlled environment under 30°C free of dust.
- Please consult the Violumas engineering team for further information on storage precautions.

Eye Safety Precautions

- Avoid exposure to UV light during LED operation. Do not look directly into the UV light during LED operation. Do not look directly into the UV light during optical measurements even through optical instruments. Protect the body, skin, and eyes with UV protective equipment.
- Attach warning labels on all products and systems that use UV LEDs.

Cleaning Precautions

- Do not use brushes or organic solvents for cleaning the LEDs.
- Perform electrical and optical measurements before and after cleaning to ensure optimal performance.

Static Electricity Precautions

- Ensure that equipment and machinery are properly grounded.
- Anti-electrostatic attire (wristbands, gloves, footwear, etc.) is recommended.
- Damage inspection is recommended while performing characteristics inspection of LEDs.

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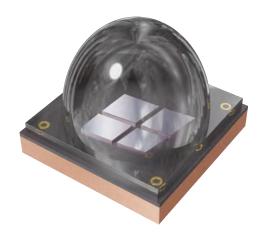




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VS7272C48L6-310-V1 | High Power 310nm SMD

The VS7272C48L6-310-V1 is a high power surface-mount-device (SMD) UV LED with a peak wavelength of 308±5nm. The SMD is structured with four patented 3-PAD LED Flip Chips mounted onto a copper-based Pillar substrate to boost output efficiency and reduce the thermal resistance. The VS7272C48L6-310-V1 is packaged in a four-chip structure with a 60° fused silica lens and is ideal for high power UV applications.



*VS7272C48L6-310-V1 is also available with a 135° lens. Please contact Violumas for specifications regarding alternative LED beam angles.

Features & Benefits

- Dimensions: 7.2mm x 7.2mm x 6.0mm
- Typical Peak Wavelength: 308nm
- Equipped with a 60° fused silica lens*
- Integrated thermal technology in LED chips and substrate for lowest thermal resistance & reduced thermal decay

Electro-Optical Characteristics at $\rm I_F{=}1400mA$ and $\rm T_A{=}25^{\circ}C$

Parameter	Symbol	Unit	Min	Typical	Max
Peak Wavelength	$\lambda_{\rm P}$	nm	303	308	313
Forward Voltage	V _F	V	11.0	12.0	14.0
Radiant Flux	Po	mW	370	440	520
Full Width of Half Magnitude	Δλ	nm	-	15	-
Radiant Angle	2Φ _{1/2}	Degree	-	60	-
Thermal Resistance, Junction to Solder Joint	R _{th} (J-S)	°C/W	-	0.32	-

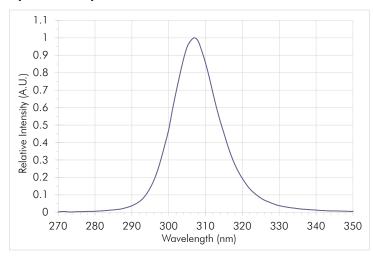
Peak Wavelength Tolerance: ±3nm; Forward Voltage Tolerance: 0.1V; Radiant Flux Tolerance: ±10%

Absolute Maximum Ratings

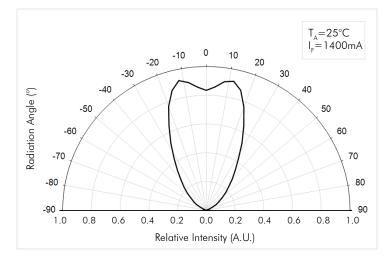
Parameter	Symbol	Unit	Value
Forward Current	۱ _۴	mA	2000
Reverse Voltage	V _R	V	10
Power	P _D	W	26
Junction Temperature	T,	°C	90
Operating Temperature	T _{OPR}	°C	-30 ~ 85
Storage Temperature	T _{stg}	°C	-40 ~ 100

Note: Operating the LED at or above the listed absolute maximum ratings may affect device reliability and result in permanent LED failure.

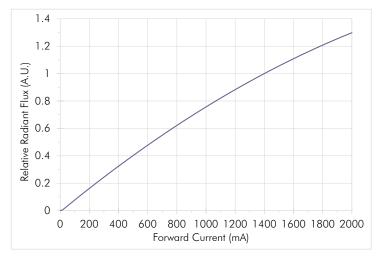
Spectral Output



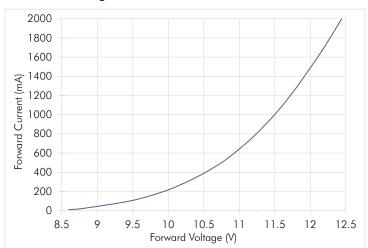
Radiation Pattern

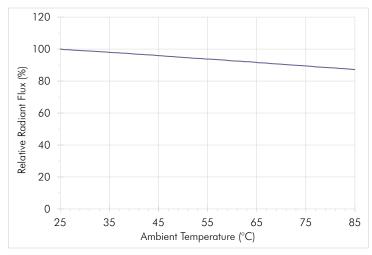


Forward Current vs. Relative Radiant Flux



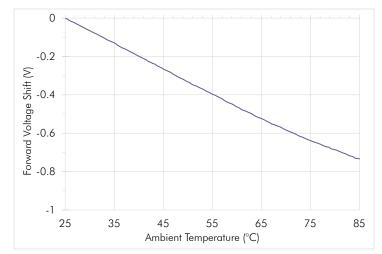
Forward Voltage vs. Forward Current



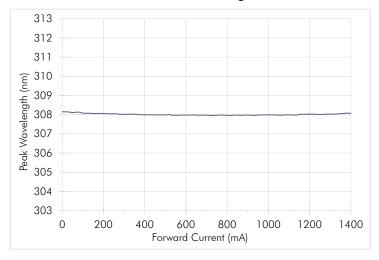


Ambient Temperature vs. Relative Radiant Flux

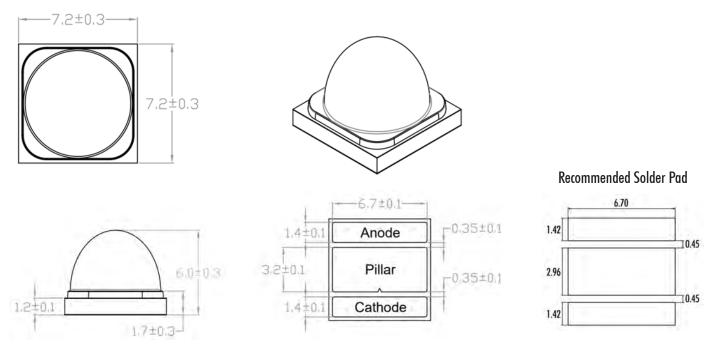
Ambient Temperature vs. Forward Voltage Shift



Forward Current vs. Peak Wavelength



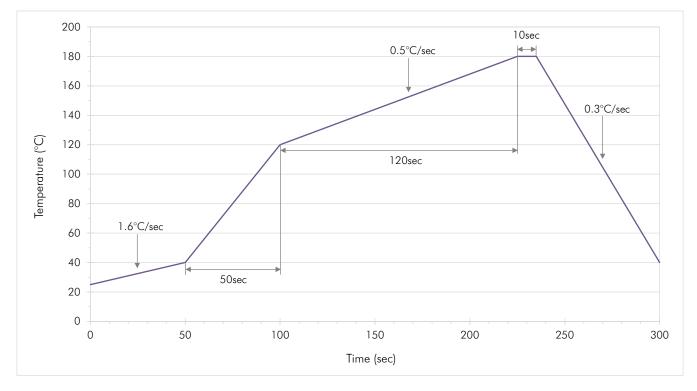
Mechanical Dimensions



Note: The maximum offset (tolerance) for lens alignment over the LED is 0.2mm.

High Power 310nm SMD

Soldering Guidelines



Reflow Profile Feature	Standard Parameters
Preheat Temperature Minimum	40°C
Preheat Temperature Maximum	120°C
Preheat Time	50 sec
Preheat Ramp-Up Rate	1.6°C/sec
Peak Temperature	±5°C
Time from Preheat Maximum Temperature to Peak Temperature	120 sec
Ramp-Up Rate from Maximum Temperature to Peak Temperature	0.5°C/sec
Time Within 5°C of Peak Temperature	5 sec
Maximum Time Maintained at Peak Temperature within Tolerance	10 sec
Ramp-Down Rate	3°C/sec

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Reliability Tests

Test	Conditions	Test Duration	Failed/Tested
Resistance to Soldering Heat	T _{sLD} =180°C, 10sec Precondition: 30°C, 70%RH, 168hrs	2 reflows	0/5
Thermal Shock	-45°C to 125°C, 15min	500 cycles	0/5
High Temperature Storage	T _A =100°C	1000 hrs	0/5
Low Temperature Storage	$T_A = -40^{\circ}C$	1000 hrs	0/5
Room Temperature Operating Life	T _A =25°C, I _F =1400mA	1000 hrs	0/5
Wet High Temperature Operating Life	T _A =60°C, RH=90%, I _F =1400mA	1000 hrs	0/5
Vibration	200m/s², 10~2000~100Hz 4cycles, 4min, on X/Y/Z axis	48 min	0/5

Failure Criteria: Forward Voltage (I_F =1400mA) > Initial Value x 1.1; Radiant Flux (I_F =1400mA) < Initial Value x 0.7

Handling & Usage Precautions

- Exhibit extreme care when handling LEDs. Do not touch the LED with bare hands as doing so may contaminate and affect the optical characteristics of the LED. When using tweezers, do not apply excessive force, especially to the glass lens. Do not drop the LED as doing so may cause product damage.
- Ensure that electrostatic discharge specifications are followed. Static electricity and surge voltages may cause product damage. Proper electrostatic discharge protection equipment, working machinery, and protected mounting equipment are recommended.
- Do not expose the LEDs to volatile organic compounds as well as hazardous, acidic, and corrosive substances during storage and operation to avoid product damage.
- Do not apply excess mechanical force and vibration while handling the product.
- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation.
- Ensure that the PCB is suitable for the product and be wary of LED placement and possible PCB warpage.
- To avoid fault issues, do not couple any electrical wires to the metal substrate of the MCPCB or COB. If any
 electrical wires from the power source have contact with the MCPCB's metal base under power ON conditions,
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- Avoid grounding of the LED copper substrate. Transient charges can propagate from the ground to the heatsink and finally to the copper substrate of the LED unit and damage the dielectric layer from ground charges. An insulator must be placed between the heatsink and the benchtop to avoid transient charge propagation from the ground.

Storage Precautions

- Perform soldering as soon as the moisture-proof packaging is opened.
- After the storage duration has exceeded the recommended time, products may need to be baked before soldering.
- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation. It is recommended to store all products in a controlled environment under 30°C free of dust.
- Please consult the Violumas engineering team for further information on storage precautions.

Eye Safety Precautions

- Avoid exposure to UV light during LED operation. Do not look directly into the UV light during LED operation. Do not look directly into the UV light during optical measurements even through optical instruments. Protect the body, skin, and eyes with UV protective equipment.
- Attach warning labels on all products and systems that use UV LEDs.

Cleaning Precautions

- Do not use brushes or organic solvents for cleaning the LEDs.
- Perform electrical and optical measurements before and after cleaning to ensure optimal performance.

Static Electricity Precautions

- Ensure that equipment and machinery are properly grounded.
- Anti-electrostatic attire (wristbands, gloves, footwear, etc.) is recommended.
- Damage inspection is recommended while performing characteristics inspection of LEDs.

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Revision History

- 09/25/2023: Release of initial version
- 11/04/2024: Addition of Ambient Temperature vs. Relative Radiant Flux, Ambient Temperature vs. Forward Voltage Shift, Forward Current vs. Peak Wavelength, and Reliability Tests
- 04/07/2025: Revision of Radiation Pattern and Mechanical Drawing



Data Sheet **Boston**Electronics

VC1X1C48L6-310-V1 | Mid Power 310nm COB

The VC1X1C48L6-310-V1 is a mid power chip-on-board (COB) UV LED with a peak wavelength of 308±5nm. The COB is structured with a patented 3-PAD Flip Chip LED mounted onto a copper-based Pillar MCPCB to boost output efficiency and reduce the thermal resistance. The VC1X1C48L6-310-V1 is ready for plug and play with no soldering required and is ideal for mid power UV applications.



*VC1X1C48L6-310-V1 is also available with 30°, 120°, and 135° lenses. Please contact Violumas for specifications regarding alternative LED beam angles.

Features & Benefits

- Dimensions: 15mm x 15mm x 3.3mm
- Typical Peak Wavelength: 308nm
- Equipped with a $60^\circ\,\text{fused silica lens}^*$
- Ready for plug and play (solder-free)
- Poke-in connectors for easy wiring
- TVS built in for ESD protection
- Integrated thermal technology in LED chip and MCPCB for lowest thermal resistance & reduced thermal decay



Electro-Optical Characteristics at $\rm I_{\rm F}{=}700mA$ and $\rm T_{\rm A}{=}25^{\circ}C$

Parameter	Symbol	Unit	Min	Typical	Max
Peak Wavelength	λ_{P}	nm	303	308	313
Forward Voltage	V _F	V	5.5	6.0	7.0
Radiant Flux	P_{o}	mW	100	120	140
Full Width of Half Magnitude	Δλ	nm	-	15	-
Radiant Angle	2Φ _{1/2}	Degree	-	60	-
Thermal Resistance, Junction to COB Bottom Surface	R _{th} (J-B)	°C/W	-	0.9	-

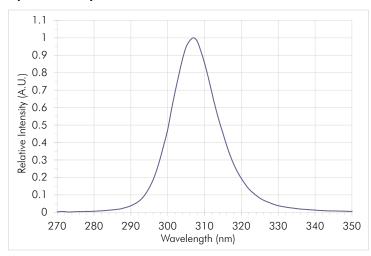
Peak Wavelength Tolerance: ±3nm; Forward Voltage Tolerance: 0.1V; Radiant Flux Tolerance: ±10%

Absolute Maximum Ratings

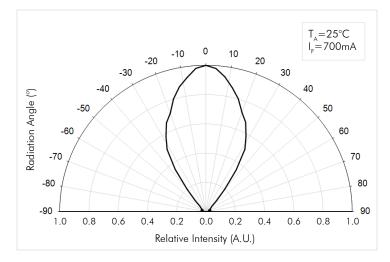
Parameter	Symbol	Unit	Value
Forward Current	١ _F	mA	1000
Reverse Voltage	V _R	V	5
Power	P _D	W	6.5
Junction Temperature	T,	°C	90
Operating Temperature	T _{OPR}	°C	-30 ~ 85
Storage Temperature	T _{stg}	°C	-40 ~ 100

Note: Operating the LED at or above the listed absolute maximum ratings may affect device reliability and result in permanent LED failure.

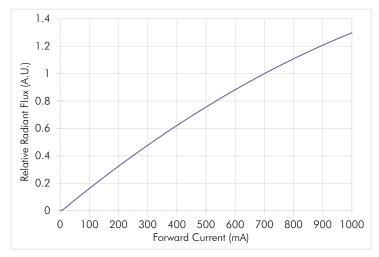
Spectral Output



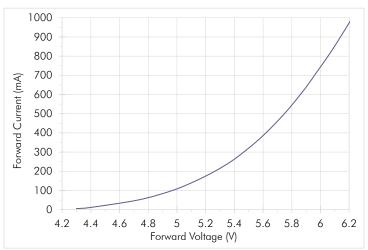
Radiation Pattern

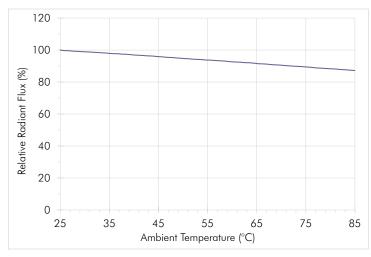


Forward Current vs. Relative Radiant Flux



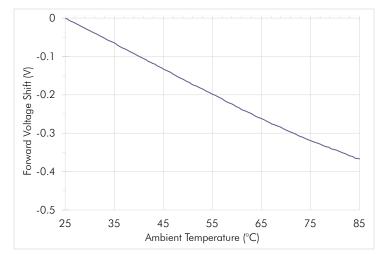
Forward Voltage vs. Forward Current



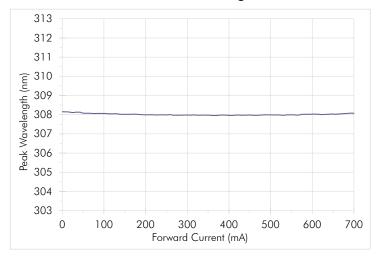


Ambient Temperature vs. Relative Radiant Flux

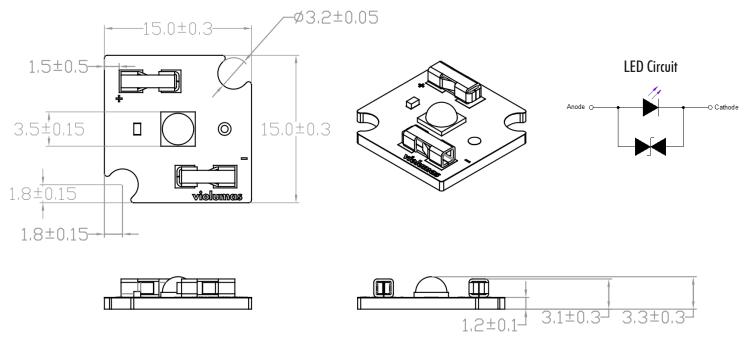
Ambient Temperature vs. Forward Voltage Shift



Forward Current vs. Peak Wavelength



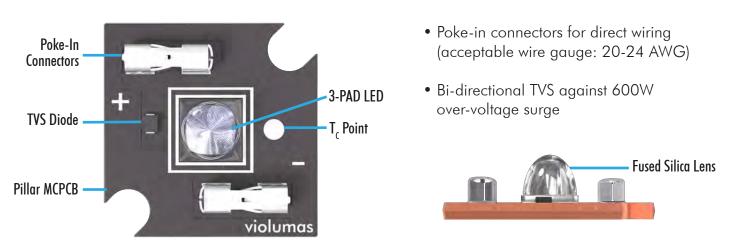
Mechanical Dimensions



Note: The maximum offset (tolerance) for lens alignment over the LED is 0.2mm.

Product Overview

COB LEDs are ready for plug and play with no soldering required. All Violumas COBs are equipped with connectors for direct wiring and a TVS diode for protection against ESD and voltage issues.



Note: Violumas COB products may be delivered with a protective tape on the backside of the LED. The tape should be removed before operation or assembly.

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Reliability Tests

Test	Conditions	Test Duration	Failed/Tested
Thermal Shock	-45°C to 125°C, 15min	500 cycles	0/5
High Temperature Storage	T _A =100°C	1000 hrs	0/5
Low Temperature Storage	T _A =-40°C	1000 hrs	0/5
Room Temperature Operating Life	T _A =25°C, I _F =700mA	1000 hrs	0/5
Wet High Temperature Operating Life	T _A =60°C, RH=90%, I _F =700mA	1000 hrs	0/5
Vibration	200m/s², 10~2000~100Hz 4cycles, 4min, on X/Y/Z axis	48 min	0/5
Electrostatic Discharge	HBM, 30kV, 400W @ 10/1000us pulse, bi-directional	3 times	0/5

Failure Criteria: Forward Voltage (I_F =700mA) > Initial Value x 1.1; Radiant Flux (I_F =700mA) < Initial Value x 0.7

Handling & Usage Precautions

- Exhibit extreme care when handling LEDs. Do not touch the LED with bare hands as doing so may contaminate and affect the optical characteristics of the LED. When using tweezers, do not apply excessive force, especially to the glass lens. Do not drop the LED as doing so may cause product damage.
- Ensure that electrostatic discharge specifications are followed. Static electricity and surge voltages may cause product damage. Proper electrostatic discharge protection equipment, working machinery, and protected mounting equipment are recommended.
- Do not expose the LEDs to volatile organic compounds as well as hazardous, acidic, and corrosive substances during storage and operation to avoid product damage.
- Do not apply excess mechanical force and vibration while handling the product.
- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation.
- To avoid fault issues, do not couple any electrical wires to the metal substrate of the MCPCB or COB. If any electrical wires from the power source have contact with the MCPCB's metal base under power ON conditions, permanent damage may occur due to inner arcing within the LED structure.
- Avoid grounding of the LED copper substrate. Transient charges can propagate from the ground to the heatsink and finally to the copper substrate of the LED unit and damage the dielectric layer from ground charges. An insulator must be placed between the heatsink and the benchtop to avoid transient charge propagation from the ground.

Storage Precautions

- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation. It is recommended to store all products in a controlled environment under 30°C free of dust.
- Please consult the Violumas engineering team for further information on storage precautions.

Eye Safety Precautions

- Avoid exposure to UV light during LED operation. Do not look directly into the UV light during LED operation. Do not look directly into the UV light during optical measurements even through optical instruments. Protect the body, skin, and eyes with UV protective equipment.
- Attach warning labels on all products and systems that use UV LEDs.

Cleaning Precautions

- Do not use brushes or organic solvents for cleaning the LEDs.
- Perform electrical and optical measurements before and after cleaning to ensure optimal performance.

Static Electricity Precautions

- Ensure that equipment and machinery are properly grounded.
- Anti-electrostatic attire (wristbands, gloves, footwear, etc.) is recommended.
- Damage inspection is recommended while performing characteristics inspection of LEDs.

Disclaimers

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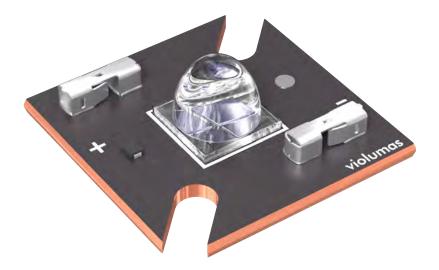
Data Sheet



BostonElectronics

VC2X2C48L6-310-V1 | High Power 310nm COB

The VC2X2C48L6-310-V1 is a high power chip-on-board (COB) UV LED with a peak wavelength of 308±5nm. The COB is structured with four patented 3-PAD Flip Chip LEDs mounted onto a copper-based Pillar MCPCB to boost output efficiency and reduce the thermal resistance. The VC2X2C48L6-310-V1 is ready for plug and play with no soldering required and is ideal for high power UV applications.



*VC2X2C48L6-310-V1 is also available with a 135° lens. Please contact Violumas for specifications regarding alternative LED beam angles.

Features & Benefits

- Dimensions: 20mm x 20mm x 6.0mm
- Typical Peak Wavelength: 308nm
- Equipped with a 60° fused silica lens*
- Ready for plug and play (solder-free)
- Poke-in connectors for easy wiring
- TVS built in for ESD protection
- Integrated thermal technology in LED chips and MCPCB for lowest thermal resistance & reduced thermal decay

Electro-Optical Characteristics at $\rm I_F{=}1400mA$ and $\rm T_A{=}25^{\circ}C$

Parameter	Symbol	Unit	Min	Typical	Max
Peak Wavelength	λ_{P}	nm	303	308	313
Forward Voltage	V _F	V	11.0	12.0	14.0
Radiant Flux	P_{o}	mW	370	440	520
Full Width of Half Magnitude	Δλ	nm	-	15	-
Radiant Angle	2Φ _{1/2}	Degree	-	60	-
Thermal Resistance, Junction to COB Bottom Surface	R _{th} (J-B)	°C/W	-	0.32	-

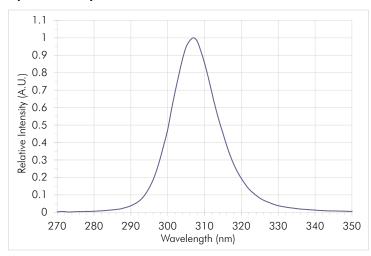
Peak Wavelength Tolerance: ±3nm; Forward Voltage Tolerance: 0.1V; Radiant Flux Tolerance: ±10%

Absolute Maximum Ratings

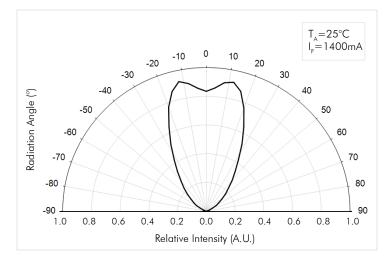
Parameter	Symbol	Unit	Value
Forward Current	۱ _۴	mA	2000
Reverse Voltage	V _R	V	10
Power	P _D	W	26
Junction Temperature	TJ	°C	90
Operating Temperature	T _{OPR}	°C	-30 ~ 85
Storage Temperature	T _{STG}	°C	-40 ~ 100

Note: Operating the LED at or above the listed absolute maximum ratings may affect device reliability and result in permanent LED failure.

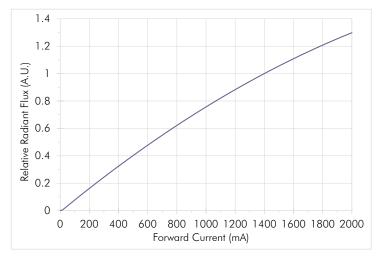
Spectral Output



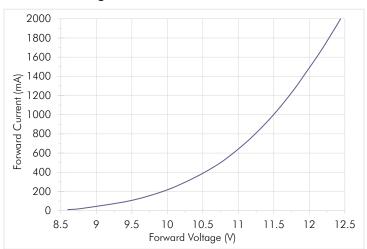
Radiation Pattern

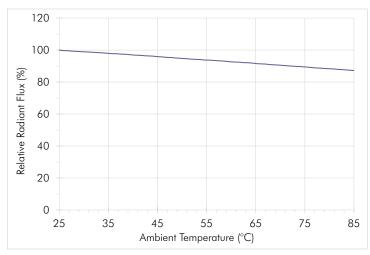


Forward Current vs. Relative Radiant Flux



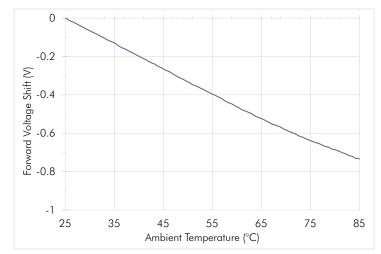
Forward Voltage vs. Forward Current



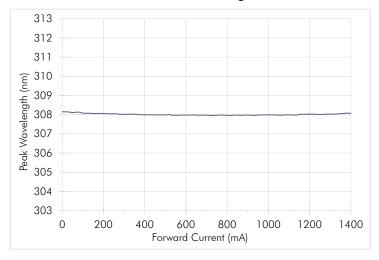


Ambient Temperature vs. Relative Radiant Flux

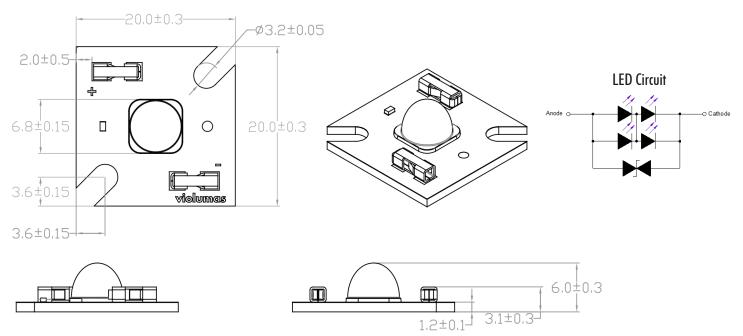
Ambient Temperature vs. Forward Voltage Shift



Forward Current vs. Peak Wavelength



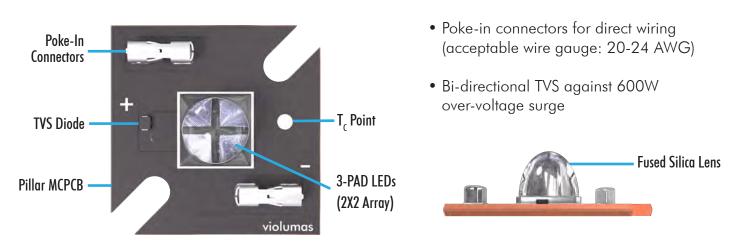
Mechanical Dimensions



Note: The maximum offset (tolerance) for lens alignment over the LED is 0.2mm.

Product Overview

COB LEDs are ready for plug and play with no soldering required. All Violumas COBs are equipped with connectors for direct wiring and a TVS diode for protection against ESD and voltage issues.



Note: Violumas COB products may be delivered with a protective tape on the backside of the LED. The tape should be removed before operation or assembly.

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Reliability Tests

Test	Conditions	Test Duration	Failed/Tested
Thermal Shock	-45°C to 125°C, 15min	500 cycles	0/5
High Temperature Storage	T _A =100°C	1000 hrs	0/5
Low Temperature Storage	T _A =-40°C	1000 hrs	0/5
Room Temperature Operating Life	T _A =25°C, I _F =1400mA	1000 hrs	0/5
Wet High Temperature Operating Life	T _A =60°C, RH=90%, I _F =1400mA	1000 hrs	0/5
Vibration	200m/s², 10~2000~100Hz 4cycles, 4min, on X/Y/Z axis	48 min	0/5
Electrostatic Discharge	HBM, 30kV, 400W @ 10/1000us pulse, bi-directional	3 times	0/5

Failure Criteria: Forward Voltage (I_F =1400mA) > Initial Value x 1.1; Radiant Flux (I_F =1400mA) < Initial Value x 0.7

Handling & Usage Precautions

- Exhibit extreme care when handling LEDs. Do not touch the LED with bare hands as doing so may contaminate and affect the optical characteristics of the LED. When using tweezers, do not apply excessive force, especially to the glass lens. Do not drop the LED as doing so may cause product damage.
- Ensure that electrostatic discharge specifications are followed. Static electricity and surge voltages may cause product damage. Proper electrostatic discharge protection equipment, working machinery, and protected mounting equipment are recommended.
- Do not expose the LEDs to volatile organic compounds as well as hazardous, acidic, and corrosive substances during storage and operation to avoid product damage.
- Do not apply excess mechanical force and vibration while handling the product.
- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation.
- To avoid fault issues, do not couple any electrical wires to the metal substrate of the MCPCB or COB. If any electrical wires from the power source have contact with the MCPCB's metal base under power ON conditions, permanent damage may occur due to inner arcing within the LED structure.
- Avoid grounding of the LED copper substrate. Transient charges can propagate from the ground to the heatsink and finally to the copper substrate of the LED unit and damage the dielectric layer from ground charges. An insulator must be placed between the heatsink and the benchtop to avoid transient charge propagation from the ground.

Storage Precautions

- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation. It is recommended to store all products in a controlled environment under 30°C free of dust.
- Please consult the Violumas engineering team for further information on storage precautions.

Eye Safety Precautions

- Avoid exposure to UV light during LED operation. Do not look directly into the UV light during LED operation. Do not look directly into the UV light during optical measurements even through optical instruments. Protect the body, skin, and eyes with UV protective equipment.
- Attach warning labels on all products and systems that use UV LEDs.

Cleaning Precautions

- Do not use brushes or organic solvents for cleaning the LEDs.
- Perform electrical and optical measurements before and after cleaning to ensure optimal performance.

Static Electricity Precautions

- Ensure that equipment and machinery are properly grounded.
- Anti-electrostatic attire (wristbands, gloves, footwear, etc.) is recommended.
- Damage inspection is recommended while performing characteristics inspection of LEDs.

Disclaimers

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Revision History

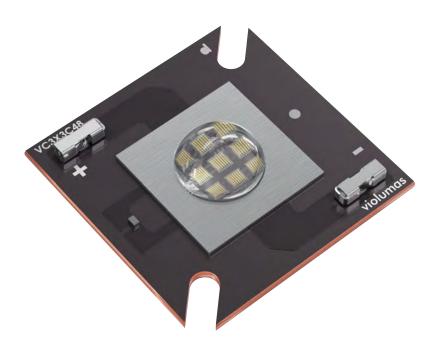
- 09/25/2023: Release of initial version
- 11/04/2024: Addition of Ambient Temperature vs. Relative Radiant Flux, Ambient Temperature vs. Forward Voltage Shift, Forward Current vs. Peak Wavelength, and Reliability Tests
- 04/07/2025: Revision of Radiation Pattern and Mechanical Drawing



Data Sheet

VC3X3C48L9-310-V1 | High Density 310nm COB

The VC3X3C48L9-310-V1 is a high density chip-on-board (COB) UV LED with a peak wavelength of 308±5nm. The COB is structured with nine patented 3-PAD Flip Chip LEDs mounted onto a copper-based Pillar MCPCB to boost output efficiency and reduce the thermal resistance. The VC3X3C48L9-310-V1 is ready for plug and play with no soldering required and is ideal for high intensity UV applications.



Features & Benefits

- Dimensions: 30mm x 30mm x 6.1mm
- Typical Peak Wavelength: 308nm
- \bullet Equipped with a 90° fused silica lens
- Ready for plug and play (solder-free)
- Poke-in connectors for easy wiring
- TVS built in for ESD protection
- Integrated thermal technology in LED chips and MCPCB for lowest thermal resistance & reduced thermal decay

BostonElectronics

Electro-Optical Characteristics at $\rm I_{\rm F}{=}2100mA$ and $\rm T_{\rm A}{=}25^{\circ}C$

Parameter	Symbol	Unit	Min	Typical	Max
Peak Wavelength	λ_{P}	nm	303	308	313
Forward Voltage	V _F	V	16.5	18.0	21.0
Radiant Flux	P_{o}	mW	740	910	1100
Full Width of Half Magnitude	Δλ	nm	-	15	-
Radiant Angle	2Φ _{1/2}	Degree	-	90	-
Thermal Resistance, Junction to COB Bottom Surface	R _{th} (J-B)	°C/W	-	0.1	-

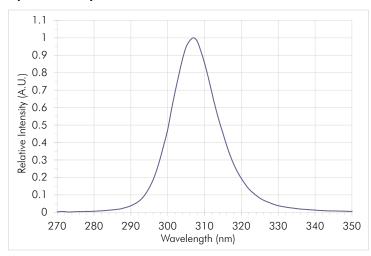
Peak Wavelength Tolerance: ±3nm; Forward Voltage Tolerance: 0.1V; Radiant Flux Tolerance: ±10%

Absolute Maximum Ratings

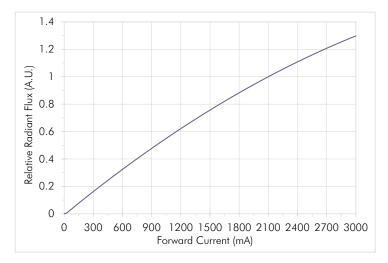
Parameter	Symbol	Unit	Value
Forward Current	۱ _۴	mA	3000
Reverse Voltage	V _R	V	15
Power	P _D	W	58.5
Junction Temperature	T,	°C	90
Operating Temperature	T _{OPR}	°C	-30 ~ 85
Storage Temperature	T _{stg}	°C	-40 ~ 100

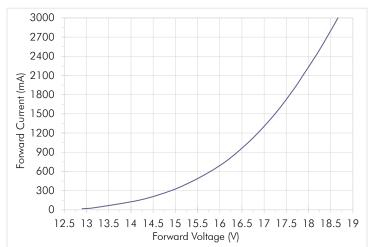
Note: Operating the LED at or above the listed absolute maximum ratings may affect device reliability and result in permanent LED failure.

Spectral Output

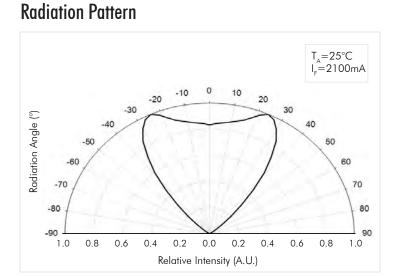


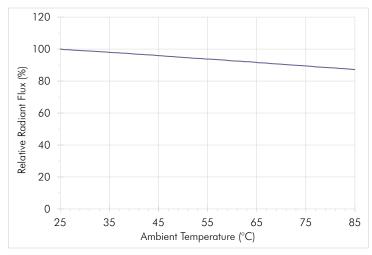
Forward Current vs. Relative Radiant Flux





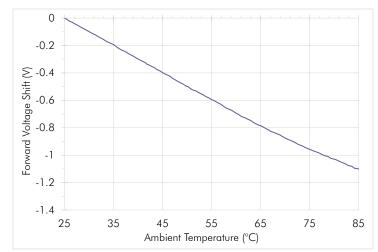
Forward Voltage vs. Forward Current



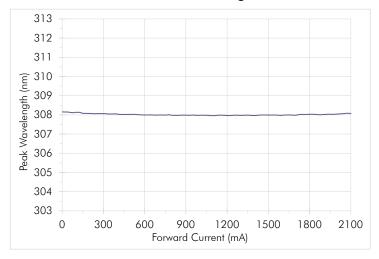


Ambient Temperature vs. Relative Radiant Flux

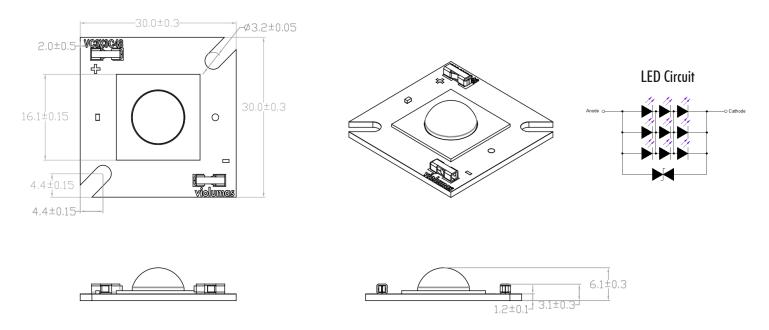
Ambient Temperature vs. Forward Voltage Shift



Forward Current vs. Peak Wavelength



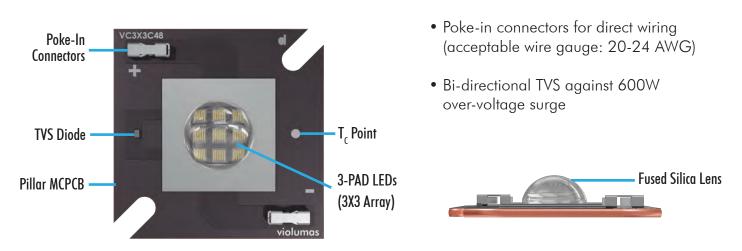
Mechanical Dimensions



Note: The maximum offset (tolerance) for lens alignment over the LED is 0.2mm.

Product Overview

COB LEDs are ready for plug and play with no soldering required. All Violumas COBs are equipped with connectors for direct wiring and a TVS diode for protection against ESD and voltage issues.



Note: Violumas COB products may be delivered with a protective tape on the backside of the LED. The tape should be removed before operation or assembly.

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Reliability Tests

Test	Conditions	Test Duration	Failed/Tested
Thermal Shock	-45°C to 125°C, 15min	500 cycles	0/5
High Temperature Storage	T _A =100°C	1000 hrs	0/5
Low Temperature Storage	T _A =-40°C	1000 hrs	0/5
Room Temperature Operating Life	T _A =25°C, I _F =2100mA	1000 hrs	0/5
Wet High Temperature Operating Life	T _A =60°C, RH=90%, I _F =2100mA	1000 hrs	0/5
Vibration	200m/s², 10~2000~100Hz 4cycles, 4min, on X/Y/Z axis	48 min	0/5
Electrostatic Discharge	HBM, 30kV, 400W @ 10/1000us pulse, bi-directional	3 times	0/5

Failure Criteria: Forward Voltage (I_F =2100mA) > Initial Value x 1.1; Radiant Flux (I_F =2100mA) < Initial Value x 0.7

Handling & Usage Precautions

- Exhibit extreme care when handling LEDs. Do not touch the LED with bare hands as doing so may contaminate and affect the optical characteristics of the LED. When using tweezers, do not apply excessive force, especially to the glass lens. Do not drop the LED as doing so may cause product damage.
- Ensure that electrostatic discharge specifications are followed. Static electricity and surge voltages may cause product damage. Proper electrostatic discharge protection equipment, working machinery, and protected mounting equipment are recommended.
- Do not expose the LEDs to volatile organic compounds as well as hazardous, acidic, and corrosive substances during storage and operation to avoid product damage.
- Do not apply excess mechanical force and vibration while handling the product.
- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation.
- To avoid fault issues, do not couple any electrical wires to the metal substrate of the MCPCB or COB. If any electrical wires from the power source have contact with the MCPCB's metal base under power ON conditions, permanent damage may occur due to inner arcing within the LED structure.
- Avoid grounding of the LED copper substrate. Transient charges can propagate from the ground to the heatsink and finally to the copper substrate of the LED unit and damage the dielectric layer from ground charges. An insulator must be placed between the heatsink and the benchtop to avoid transient charge propagation from the ground.

Storage Precautions

- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation. It is recommended to store all products in a controlled environment under 30°C free of dust.
- Please consult the Violumas engineering team for further information on storage precautions.

Eye Safety Precautions

- Avoid exposure to UV light during LED operation. Do not look directly into the UV light during LED operation. Do not look directly into the UV light during optical measurements even through optical instruments. Protect the body, skin, and eyes with UV protective equipment.
- Attach warning labels on all products and systems that use UV LEDs.

Cleaning Precautions

- Do not use brushes or organic solvents for cleaning the LEDs.
- Perform electrical and optical measurements before and after cleaning to ensure optimal performance.

Static Electricity Precautions

- Ensure that equipment and machinery are properly grounded.
- Anti-electrostatic attire (wristbands, gloves, footwear, etc.) is recommended.
- Damage inspection is recommended while performing characteristics inspection of LEDs.

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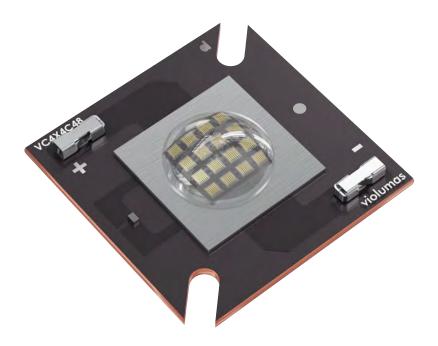
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Data Sheet

VC4X4C48L9-310-V1 | High Density 310nm COB

The VC4X4C48L9-310-V1 is a high density chip-on-board (COB) UV LED with a peak wavelength of 308±5nm. The COB is structured with sixteen patented 3-PAD Flip Chip LEDs mounted onto a copper-based Pillar MCPCB to boost output efficiency and reduce the thermal resistance. The VC4X4C48L9-310-V1 is ready for plug and play with no soldering required and is ideal for high intensity UV applications.



Features & Benefits

- Dimensions: 30mm x 30mm x 5.4mm
- Typical Peak Wavelength: 308nm
- \bullet Equipped with a 90° fused silica lens
- Ready for plug and play (solder-free)
- Poke-in connectors for easy wiring
- TVS built in for ESD protection
- Integrated thermal technology in LED chips and MCPCB for lowest thermal resistance & reduced thermal decay

BostonElectronics

Electro-Optical Characteristics at $\rm I_{\rm F}{=}2800mA$ and $\rm T_{\rm A}{=}25^{\circ}C$

Parameter	Symbol	Unit	Min	Typical	Max
Peak Wavelength	$\lambda_{\rm P}$	nm	303	308	313
Forward Voltage	V _F	V	22.0	24.0	28.0
Radiant Flux	P_{o}	mW	1240	1540	1750
Full Width of Half Magnitude	Δλ	nm	-	15	-
Radiant Angle	2Φ _{1/2}	Degree	-	90	-
Thermal Resistance, Junction to COB Bottom Surface	R _{th} (J-B)	°C/W	-	0.06	-

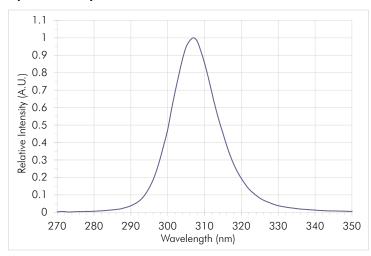
Peak Wavelength Tolerance: ±3nm; Forward Voltage Tolerance: 0.1V; Radiant Flux Tolerance: ±10%

Absolute Maximum Ratings

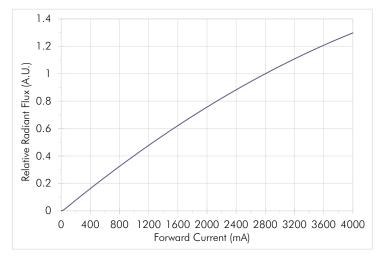
Parameter	Symbol	Unit	Value
Forward Current	۱ _F	mA	4000
Reverse Voltage	V _R	V	20
Power	P _D	W	104
Junction Temperature	T,	°C	90
Operating Temperature	T _{OPR}	°C	-30 ~ 85
Storage Temperature	T _{stg}	°C	-40 ~ 100

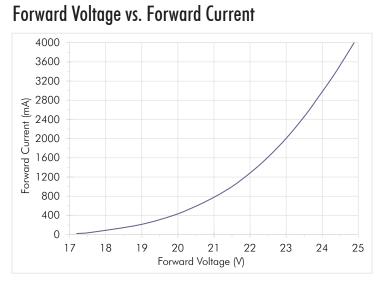
Note: Operating the LED at or above the listed absolute maximum ratings may affect device reliability and result in permanent LED failure.

Spectral Output

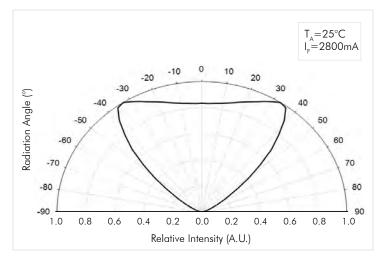


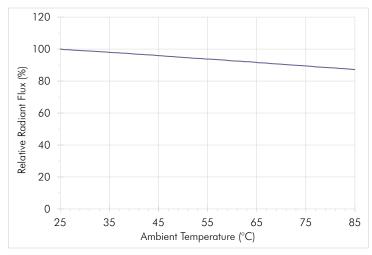
Forward Current vs. Relative Radiant Flux





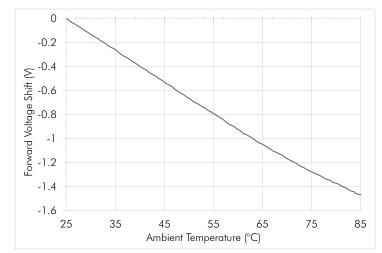
Radiation Pattern



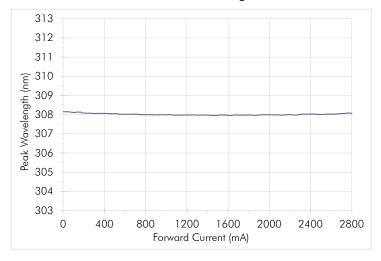


Ambient Temperature vs. Relative Radiant Flux

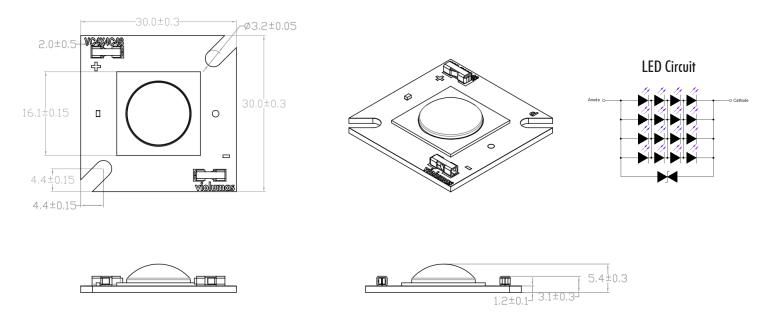
Ambient Temperature vs. Forward Voltage Shift



Forward Current vs. Peak Wavelength



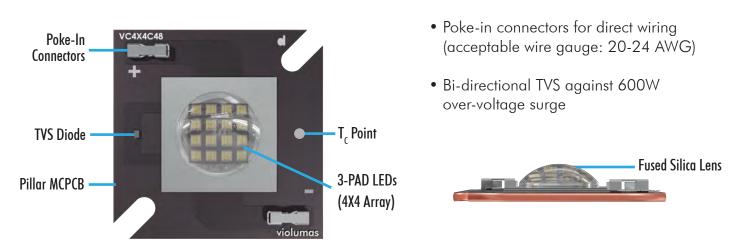
Mechanical Dimensions



Note: The maximum offset (tolerance) for lens alignment over the LED is 0.2mm.

Product Overview

COB LEDs are ready for plug and play with no soldering required. All Violumas COBs are equipped with connectors for direct wiring and a TVS diode for protection against ESD and voltage issues.



Note: Violumas COB products may be delivered with a protective tape on the backside of the LED. The tape should be removed before operation or assembly.

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Reliability Tests

Test	Conditions	Test Duration	Failed/Tested
Thermal Shock	-45°C to 125°C, 15min	500 cycles	0/5
High Temperature Storage	T _A =100°C	1000 hrs	0/5
Low Temperature Storage	$T_A = -40^{\circ}C$	1000 hrs	0/5
Room Temperature Operating Life	T _A =25°C, I _F =2800mA	1000 hrs	0/5
Wet High Temperature Operating Life	T _A =60°C, RH=90%, I _F =2800mA	1000 hrs	0/5
Vibration	200m/s², 10~2000~100Hz 4cycles, 4min, on X/Y/Z axis	48 min	0/5
Electrostatic Discharge	HBM, 30kV, 400W @ 10/1000us pulse, bi-directional	3 times	0/5

Failure Criteria: Forward Voltage (I_F =2800mA) > Initial Value x 1.1; Radiant Flux (I_F =2800mA) < Initial Value x 0.7

Handling & Usage Precautions

- Exhibit extreme care when handling LEDs. Do not touch the LED with bare hands as doing so may contaminate and affect the optical characteristics of the LED. When using tweezers, do not apply excessive force, especially to the glass lens. Do not drop the LED as doing so may cause product damage.
- Ensure that electrostatic discharge specifications are followed. Static electricity and surge voltages may cause product damage. Proper electrostatic discharge protection equipment, working machinery, and protected mounting equipment are recommended.
- Do not expose the LEDs to volatile organic compounds as well as hazardous, acidic, and corrosive substances during storage and operation to avoid product damage.
- Do not apply excess mechanical force and vibration while handling the product.
- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation.
- To avoid fault issues, do not couple any electrical wires to the metal substrate of the MCPCB or COB. If any electrical wires from the power source have contact with the MCPCB's metal base under power ON conditions, permanent damage may occur due to inner arcing within the LED structure.
- Avoid grounding of the LED copper substrate. Transient charges can propagate from the ground to the heatsink and finally to the copper substrate of the LED unit and damage the dielectric layer from ground charges. An insulator must be placed between the heatsink and the benchtop to avoid transient charge propagation from the ground.

Storage Precautions

- Do not expose the product to sudden changes in temperature, high humidity levels, and condensation. It is recommended to store all products in a controlled environment under 30°C free of dust.
- Please consult the Violumas engineering team for further information on storage precautions.

Eye Safety Precautions

- Avoid exposure to UV light during LED operation. Do not look directly into the UV light during LED operation. Do not look directly into the UV light during optical measurements even through optical instruments. Protect the body, skin, and eyes with UV protective equipment.
- Attach warning labels on all products and systems that use UV LEDs.

Cleaning Precautions

- Do not use brushes or organic solvents for cleaning the LEDs.
- Perform electrical and optical measurements before and after cleaning to ensure optimal performance.

Static Electricity Precautions

- Ensure that equipment and machinery are properly grounded.
- Anti-electrostatic attire (wristbands, gloves, footwear, etc.) is recommended.
- Damage inspection is recommended while performing characteristics inspection of LEDs.

Disclaimers

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Data Sheet

VC12X1 Series | 12-LED Light Bar COB

The VC12X1 Series is a 12-LED light bar chip-on-board (COB) UV LED available in 405nm, 395nm, 385nm, 375nm, 365nm, 310nm, 295nm, 275nm, and 265nm wavelengths. The COB is structured with twelve patented 3-PAD Flip Chip LEDs mounted onto a copper-based Pillar MCPCB to boost output efficiency and reduce the thermal resistance. The VC12X1 Series is ready for plug and play with no soldering required and is ideal for large-area UV applications.



*VC12X1 Series is also available with alternative lens types. Please contact Violumas for specifications regarding alternative LED beam angles.

Features & Benefits

- Dimensions: 304mm x 20mm
- Available in UVA, UVB, and UVC
- Equipped with 60° fused silica lenses*
- Ready for plug and play (solder-free)
- Poke-in connectors for easy wiring
- TVS built in for ESD protection
- Integrated thermal technology in LED chips and MCPCB for lowest thermal resistance & reduced thermal decay

BostonElectronics

Electro-Optical Characteristics for 405nm, 395nm, 385nm, 375nm, 365nm ($I_F = 700$ mA and $T_A = 25^{\circ}$ C)

Part Number	Wavelength	Radiant Flux	Forward Voltage	Power
VC12X1C45L6-405	405nm	12W	44.4V	31.1W
VC12X1C45L6-395	395nm	13W	44.8V	31.3W
VC12X1C45L6-385	385nm	12W	46.8V	32.8W
VC12X1C45L6-375	375nm	9W	46.8V	32.8W
VC12X1C45L6-365	365nm	6W	49.2V	34.4W

Peak Wavelength Tolerance: ±3nm; Forward Voltage Tolerance: 0.1V; Radiant Flux Tolerance: ±10%

Absolute Maximum Ratings for 405nm, 395nm, 385nm, 375nm, 365nm

Parameter	Symbol	Unit	Value
Forward Current	I _F	mA	1000
Reverse Voltage	V _R	V	60
Power	Po	W	48
Junction Temperature	T,	°C	90
Operating Temperature	T _{opr}	°C	-30 ~ 85
Storage Temperature	T _{stg}	°C	-40 ~ 100

Note: Operating the LED at or above the listed absolute maximum ratings may affect device reliability and result in permanent LED failure.

Please contact Violumas for additional information regarding performance curves, irradiance maps, and suitable heatsinks/drivers for this product.

Electro-Optical Characteristics for 310nm, 295nm, 275nm, 265nm ($I_F = 1400$ mA and $T_A = 25$ °C)

Part Number	Wavelength	Radiant Flux	Forward Voltage	Power
VC12X1C48L6-310-V1	308nm	1.44W	36.0V	50.4W
VC12X1C48L6-295	295nm	1.1W	34.8V	48.7W
VC12X1C48L6-275-V1	275nm	1.56W	37.2V	52.1W
VC12X1C48L6-265-V1	265nm	1.32W	37.2V	52.1W

Peak Wavelength Tolerance: ±3nm; Forward Voltage Tolerance: 0.1V; Radiant Flux Tolerance: ±10%

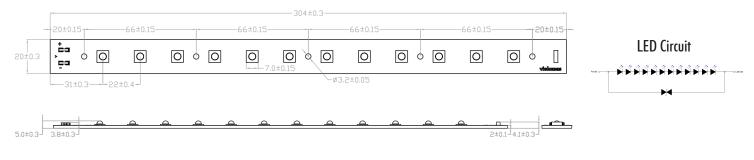
Absolute Maximum Ratings for 310nm, 295nm, 275nm, 265nm

Parameter	Symbol	Unit	Value
Forward Current	١ _F	mA	2000
Reverse Voltage	V _R	V	30
Power	Po	W	78
Junction Temperature	T,	°C	90
Operating Temperature	T _{OPR}	°C	-30 ~ 85
Storage Temperature	T _{stg}	°C	-40 ~ 100

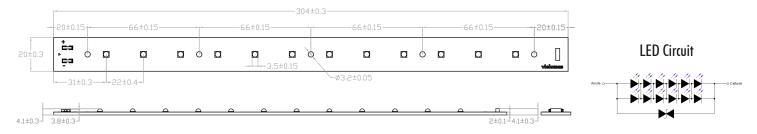
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Mechanical Dimensions for 405nm, 395nm, 385nm, 375nm, 365nm



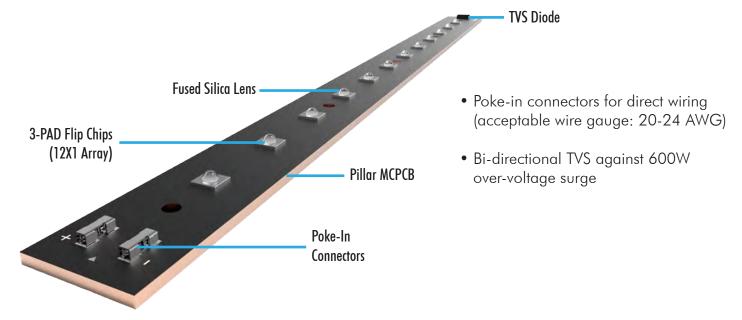
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UV LED Application Set

Plug-and-Play:

- COB UV LED
- Heatsink Kit
 - Driver Kit



Negative/Black Wire (x1), Positive/Red Wire (x1), 2-Terminal Connectors (x2)

Photos are provided for reference only and may not be accurate of the exact items received.